# **Low Noise Transistors PNP Silicon**

#### **MAXIMUM RATINGS**

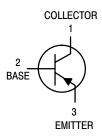
Rating	Symbol	BC559	BC560	Unit	
Collector–Emitter Voltage	V <sub>CEO</sub>	-30	-45	Vdc	
Collector-Base Voltage	V <sub>CBO</sub>	-30	-50	Vdc	
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0		Vdc	
Collector Current — Continuous	I <sub>C</sub>	-100		mAdc	
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	625 5.0		mW mW/°C	
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.5 12		Watt mW/°C	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		°C	

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/W

## BC559, B, C BC560C





## $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}\text{C unless otherwise noted})$

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = -10 mAdc, I <sub>B</sub> = 0)	BC559 BC560	V <sub>(BR)CEO</sub>	-30 -45			Vdc
Collector–Base Breakdown Voltage ( $I_C = -10 \mu Adc, I_E = 0$ )	BC559 BC560	V <sub>(BR)CBO</sub>	-30 -50	_ _	_ _	Vdc
Emitter–Base Breakdown Voltage ( $I_E = -10 \mu Adc, I_C = 0$ )		V <sub>(BR)EBO</sub>	-5.0	_	_	Vdc
Collector Cutoff Current $(V_{CB} = -30 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -30 \text{ Vdc}, I_E = 0, T_A = +125^{\circ}\text{C})$		I <sub>CBO</sub>			-15 -5.0	nAdc μAdc
Emitter Cutoff Current (V <sub>EB</sub> = -4.0 Vdc, I <sub>C</sub> = 0)		I <sub>EBO</sub>	_	_	-15	nAdc

## BC559, B, C BC560C

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

Characteristic		Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS						
DC Current Gain $(I_C = -10 \ \mu Adc, \ V_{CE} = -5.0 \ Vdc)$ $(I_C = -2.0 \ mAdc, \ V_{CE} = -5.0 \ Vdc)$	BC559B BC559C/560C BC559B BC559C/560C BC559	h <sub>FE</sub>	100 100 180 380 120	150 270 290 500	 460 800 800	_
Collector–Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}$ , $I_B = -0.5 \text{ mAdc}$ ) ( $I_C = -10 \text{ mAdc}$ , $I_B = \text{see note 1}$ ) ( $I_C = -100 \text{ mAdc}$ , $I_B = -5.0 \text{ mAdc}$ , see note 2	2)	V <sub>CE(sat)</sub>	_ _ _	-0.075 -0.3 -0.25	-0.25 -0.6 	Vdc
Base–Emitter Saturation Voltage (I <sub>C</sub> = –100 mAdc, I <sub>B</sub> = –5.0 mAdc)		V <sub>BE(sat)</sub>	_	-1.1	_	Vdc
Base–Emitter On Voltage $ \begin{array}{l} (I_C=-10~\mu\text{Adc},~V_{CE}=-5.0~\text{Vdc})\\ (I_C=-100~\mu\text{Adc},~V_{CE}=-5.0~\text{Vdc})\\ (I_C=-2.0~\text{mAdc},~V_{CE}=-5.0~\text{Vdc}) \end{array} $		V <sub>BE(on)</sub>	— — —0.55	-0.52 -0.55 -0.62	  	Vdc
SMALL-SIGNAL CHARACTERISTICS						
Current–Gain — Bandwidth Product (I <sub>C</sub> = –10 mAdc, V <sub>CE</sub> = –5.0 Vdc, f = 100 MH	z)	f <sub>T</sub>	_	250	_	MHz
Collector–Base Capacitance (V <sub>CB</sub> = -10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)		C <sub>cbo</sub>	_	2.5	_	pF
Small–Signal Current Gain ( $I_C = -2.0 \text{ mAdc}, V_{CE} = -5.0 \text{ V}, f = 1.0 \text{ kHz}$ )	BC559B BC559C/BC560C	h <sub>fe</sub>	240 450	330 600	500 900	_
Noise Figure $ \begin{array}{l} \text{Noise Figure} \\ \text{(I}_{C} = -200 \ \mu\text{Adc, V}_{CE} = -5.0 \ \text{Vdc, R}_{S} = 2.0 \ \text{k} \\ \text{(I}_{C} = -200 \ \mu\text{Adc, V}_{CE} = -5.0 \ \text{Vdc, R}_{S} = 100 \ \text{Noise} \end{array} $	,	NF <sub>1</sub> NF <sub>2</sub>	_	0.5 —	2.0 10	dB

## NOTES:

<sup>1.</sup>  $I_B$  is value for which  $I_C$  = -11 mA at  $V_{CE}$  = -1.0 V. 2. Pulse test = 300  $\mu s$  – Duty cycle = 2%.

## BC559, B, C BC560C

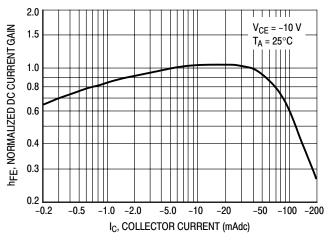


Figure 1. Normalized DC Current Gain

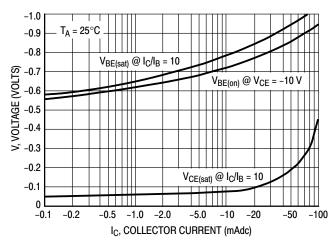


Figure 2. "Saturation" and "On" Voltages

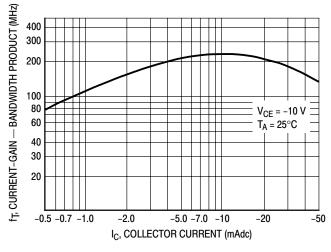


Figure 3. Current-Gain — Bandwidth Product

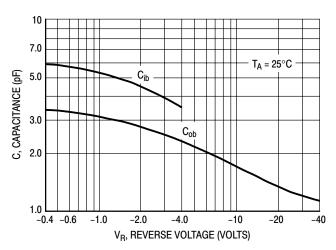


Figure 4. Capacitance

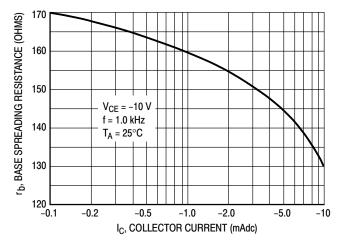
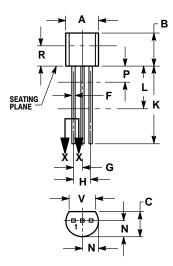
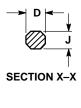


Figure 5. Base Spreading Resistance

#### PACKAGE DIMENSIONS

**CASE 029-04** (TO-226AA) ISSUE AD





#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R
  IS UNCONTROLLED.
- DIMENSION F APPLIES BETWEEN P AND L.
  DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.022	0.41	0.55
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

STYLE 17:

PIN 1. COLLECTOR 2. BASE EMITTER

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